# **GBU2504 – GBU2507** Taiwan Semiconductor

# 25A, 400V - 1000V Standard Bridge Rectifier

### FEATURES

TAIWAN

• Ideal for printed circuit board

SEMICONDUCTOR

- High surge current capability
- Low forward drop enhance the efficiency
- UL Recognized File # E-326243
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

## **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

## **MECHANICAL DATA**

• Case: GBU

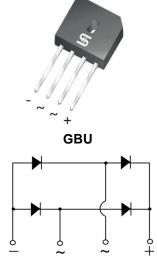
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- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Mounting torque: 0.56 N·m maximum

- Polarity: As marked
- Weight: 4.00g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I <sub>F</sub>	25	А			
V <sub>RRM</sub>	400 - 1000	V			
I <sub>FSM</sub>	300	А			
T <sub>J MAX</sub>	150 °C				
Package	GBU				
Configuration	Quad				





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	GBU2504	GBU2505	GBU2506	GBU2507	UNIT
Marking code on the device		GBU2504	GBU2505	GBU2506	GBU2507	
Repetitive peak reverse voltage	V <sub>RRM</sub>	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	280	420	560	700	V
Forward current	١ <sub>F</sub>	25			А	
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	300				A
Rating for fusing (t<8.3ms)	l <sup>2</sup> t	373			A <sup>2</sup> s	
Junction temperature	TJ	- 55 to +150			°C	
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C	







THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance	R <sub>θJL</sub>	1.3	°C/W		
Junction-to-ambient thermal resistance	R <sub>eja</sub>	6.7	°C/W		
Junction-to-case thermal resistance	R <sub>eJC</sub>	1.0	°C/W		

Thermal Performance Note: Mounted on heat sink size of 4" x 6" x 0.25" Al-Plate

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 12.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.99	1.10	V
	$I_F = 25.0A, T_J = 25^{\circ}C$		1.08	1.20	V
	$I_F = 12.5A, T_J = 125^{\circ}C$		0.89	1.00	V
	$I_F = 25.0A, T_J = 125^{\circ}C$		1.03	1.15	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	$T_J = 25^{\circ}C$	- I <sub>R</sub>	-	10	μA
	T <sub>J</sub> = 125°C		-	500	μA
Junction capacitance per diode	$1MHz, V_R = 4.0V$	CJ	100	-	pF

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING			
GBU25x	GBU	20 / Tube			

Notes:

1. "x" defines voltage from 400V(GBU2504) to 1000V(GBU2507)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

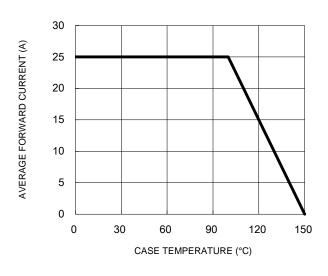
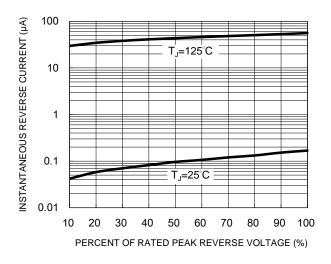


Fig.1 Forward Current Derating Curve

#### **Fig.3 Typical Reverse Characteristics**



1000 (f) = 100 (f) = 1.0MHz (f) = 1.0MHz

#### REVERSE VOLTAGE (V)

#### **Fig.4 Typical Forward Characteristics**

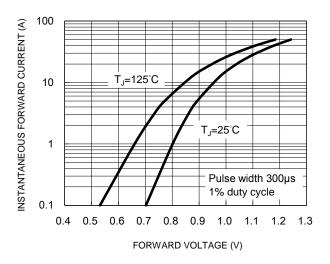


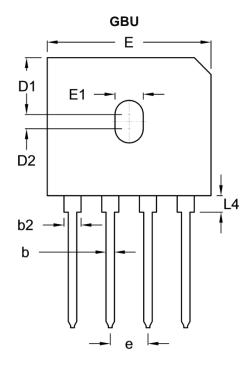
Fig.2 Typical Junction Capacitance

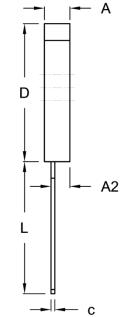


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## PACKAGE OUTLINE DIMENSIONS





DIM.	Unit (mm)		Unit (	(inch)
DIN.	Min.	Max.	Min.	Max.
А	3.30	3.56	0.130	0.140
A2	2.40	2.66	0.094	0.105
b	1.02	1.27	0.040	0.050
b2	2.06	2.54	0.081	0.100
с	0.46	0.56	0.018	0.022
D	18.30	18.80	0.720	0.740
D1	7.40	7.90	0.291	0.311
D2	1.65	2.16	0.065	0.085
Е	21.80	22.30	0.858	0.878
E1	3.50	4.10	0.138	0.161
е	4.83	5.33	0.190	0.210
L	17.50	18.00	0.689	0.709
L4	1.91	2.54	0.075	0.100

#### **MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound
- YWW = Date Code
- F = Factory Code



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